

SolidMatrix[®] Surface Mount Fuses

F1206HB Series (High Current, 1206 Size)



Features:

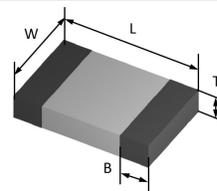
- Special products for high current rating applications
- Higher current ratings and excellent inrush current withstanding capability (high I^2t)
- Glass ceramic monolithic structure
- Silver fusing element and silver termination with nickel and tin plating
- Superior arc suppression capability
- Symmetrical design with marking on both sides (optional)

Clearing Time Characteristics:

% of current rating	Clearing time at 25°C	
	Min.	Max.
100%	4 hours	-
350%	-	5 seconds

Shape and Dimensions:

Unit	Inch	mm
L	0.126 ± 0.008	3.20 ± 0.20
W	0.063 ± 0.008	1.60 ± 0.20
T	0.038 ± 0.008	0.97 ± 0.20
B	0.020 ± 0.010	0.51 ± 0.25



Applications:

- Power tools
- DC-DC convert
- Display
- PC & Notebook
- Server
- Battery pack

Ordering Information:

Part Number	Current Rating (A)	Voltage Rating (V DC)	Interrupting Ratings	Nominal Cold DCR(Ω) ¹	Nominal I^2t (A^2s) ²	Marking Code ³
F1206HB10V024TM	10	24	150 A at rated voltage	0.0045	12	Q
F1206HB12V024TM	12	24		0.0039	19	X
F1206HB15V024TM	15	24	200 A at rated voltage	0.0031	34	Y
F1206HB20V024TM	20	24		0.0020	64	Z
F1206HB25V024TM	25	24	250 A at rated voltage	0.0016	187	S
F1206HB30V024TM	30	24	300 A at rated voltage	0.0012	270	V

1. Measured at $\leq 10\%$ rated current and 25 °C ambient

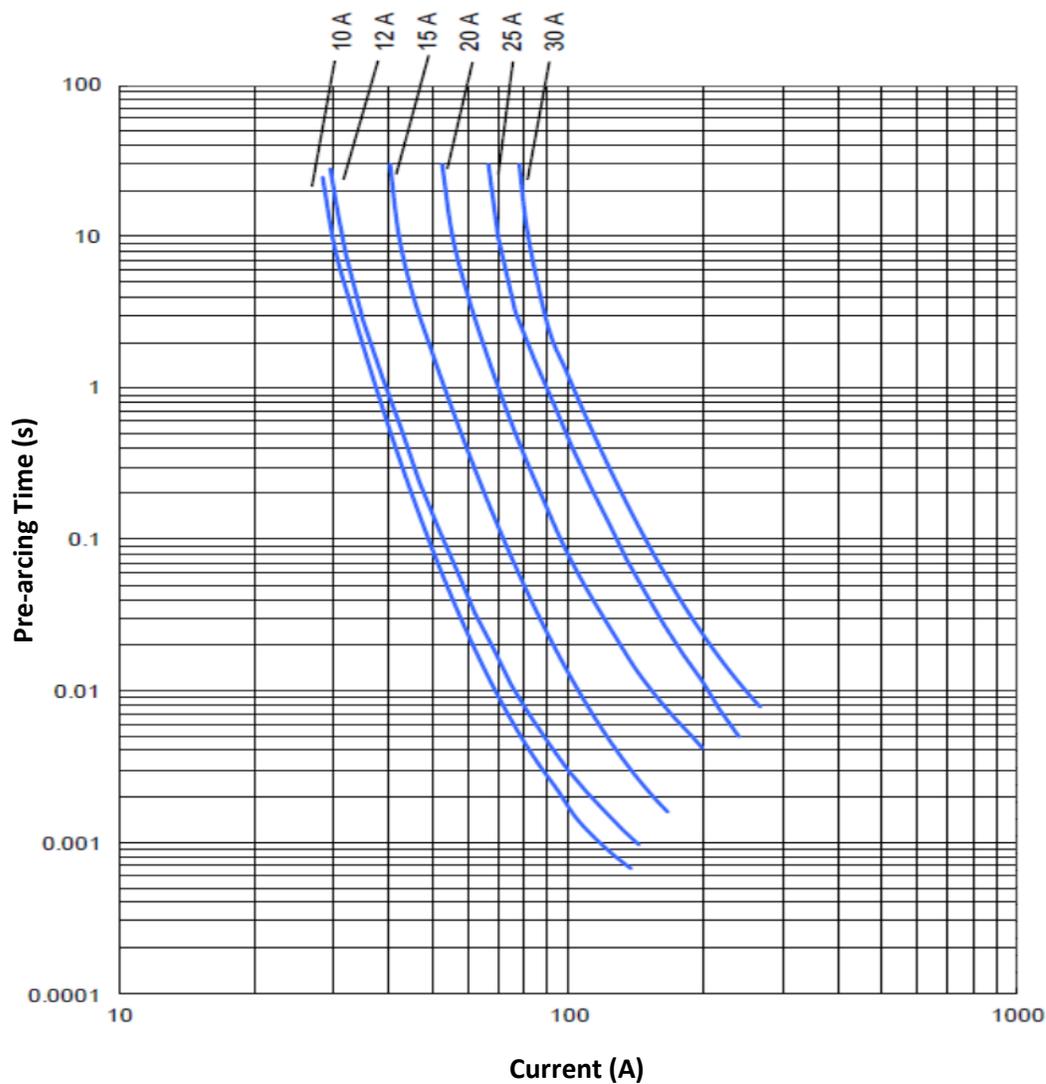
2. Melting I^2t at 1000% of current rating.

3. Red marking character code.

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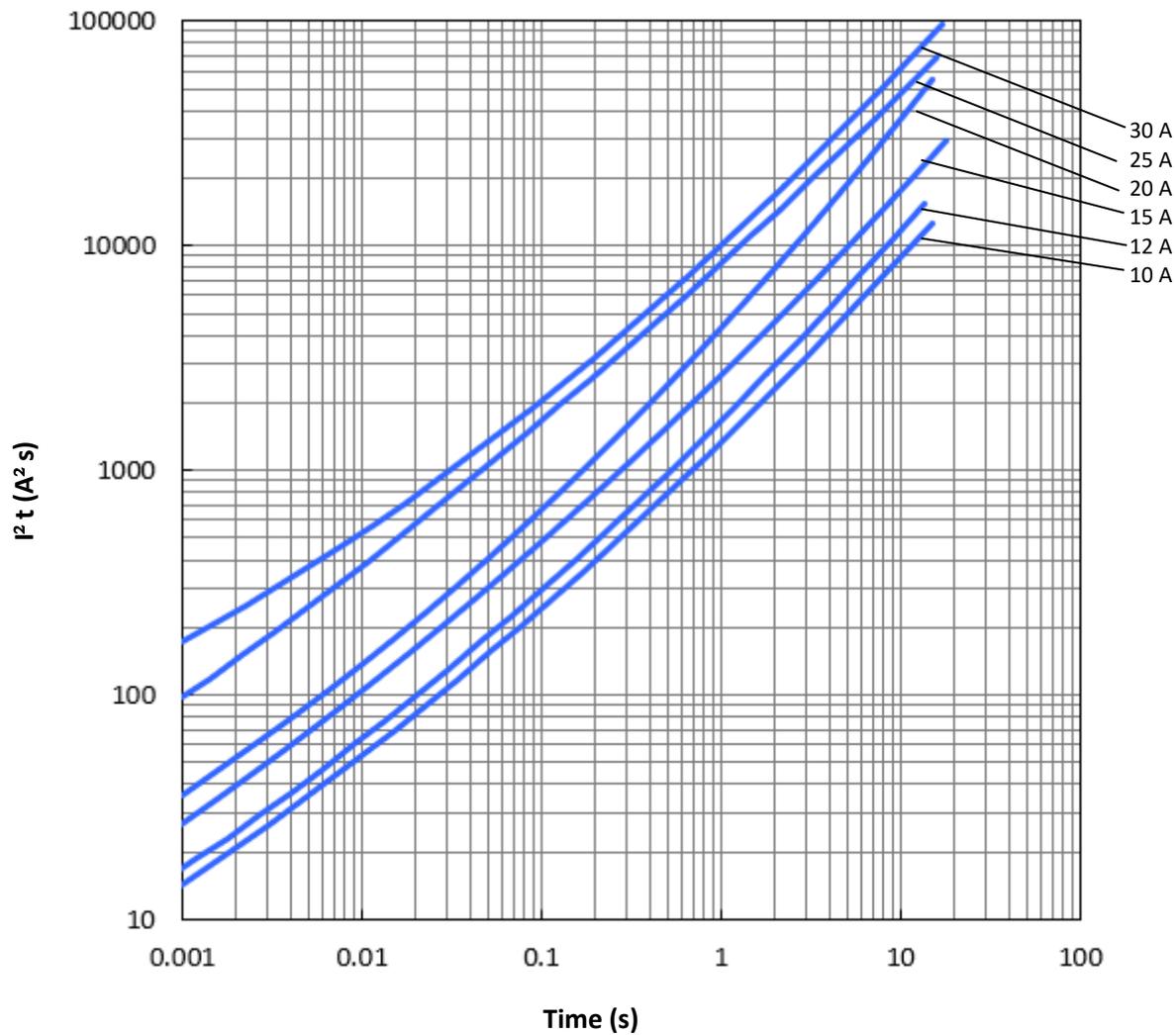
Average Pre-arcing Time Curves:



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Average I^2t vs. t Curves:

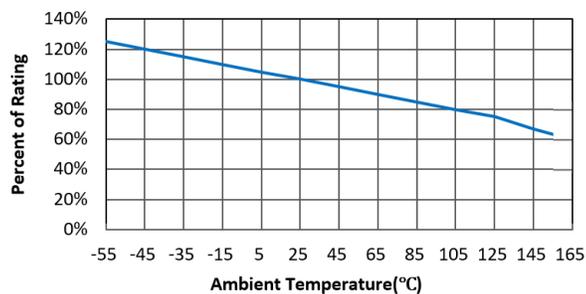


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Temperature De-rating:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C, the fuse shall be “de-rated” according to the de-rating curve.



Operating Temperature Range:

- 55°C ~+150°C (with de-rating)

Product Identification:

F 1206 HB 10 V024 T M

(1) (2) (3) (4) (5) (6)(7)

- Series Code:** SolidMatrix Surface Mount Fuses
- Size Code:** L x W (inch), the first two digits - L (length), the last two digits - W (width)
- Characteristic Code:** HB - High Current
- Current Rating Code:** 10 - 10A
- Voltage Rating code:** V024 - 24V DC
- Package Code:** T - Tape & Reel, B - Bulk
- Marking Code:** M - With marking

Agency Approval:

- Recognized Under the Components Program of Underwriters Laboratories.
- Certification #: UL-E232989

Reliability Tests:

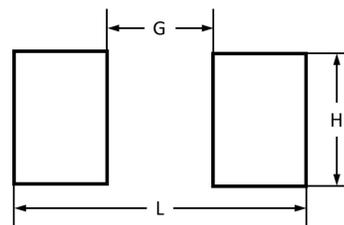
No.	Item	Condition	Criteria
1	Bend	2 mm bend	DCR change within ±20%. (±10% for ≤1A), no mechanical damage
2	Solderability	245°C, 5 seconds	New solder coverage ≥95%
3	Soldering Heat Resistance	260°C, 60 seconds	DCR change within ±10%, new solder coverage 75% minimum, no mechanical damage
4	Terminal Strength	Gradually apply 0.5 kg force to the side of the part for 60 seconds	DCR change within ±10%, no mechanical damage
5	Life	80% rated current (75% for <1A), 2000 hours, ambient temperature +20°C to +30°C	Voltage drop change within ±10%
6	Thermal Shock	-65°C to +150°C, 100 cycles	DCR change within ±10%, no mechanical damage
7	Mechanical Vibration	5 – 3000 Hz, 0.4 inch double amplitude or 30 G peak	DCR change within ±10%, no mechanical damage
8	Mechanical Shock	1500 G, 0.5 milliseconds, half-sine shocks	DCR change within ±10%, no mechanical damage
9	Salt Spray	5% salt solution, 48 hours exposure	DCR change within ±10%, no excessive corrosion
10	Moisture Resistance	10 cycles	DCR change within ±10%, no excessive corrosion

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Recommended Land Pattern:

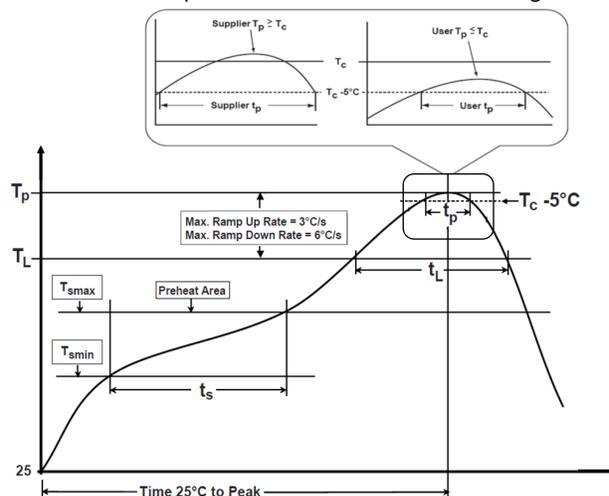
Chip Size	1206	Unit
L	0.173 (4.40)	Inch (mm)
G	0.059 (1.50)	Inch (mm)
H	0.071 (1.80)	Inch (mm)



Recommended Temperature Profile:

Profile Feature	Pb-Free Assembly
Preheat/Soak	
Temperature Min (T_{smin})	150°C
Temperature Max (T_{smax})	200°C
Time (t_s) from (T_{smin} to T_{smax})	60~120 seconds
Ramp-up rate (T_L to T_p)	3°C/second max.
Liquidous temperature (T_L)	217°C
Time (t_L) maintained above T_L	60~150 seconds
Peak package body temperature (T_p)	260°C
Time (t_p)*within 5°C of the specified classification temperature (T_c)	30 seconds *
Ramp-down rate (T_p to T_L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.
* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum	

* Recommended Temperature Profile for Reflow Soldering



Recommended conditions for hand soldering:

- Appropriate temperature (max.) of soldering iron tip/soldering time (max.): 280°C / 10 s or 350°C / 3 s
- Using hot air rework station with tip that can melt the solder on both terminations at the same time is strongly recommended. Do not directly contact the chip termination with the tip of soldering iron.

Storage:

- The maximum ambient temperature shall not exceed 35°C . Storage temperatures higher than 35°C could result in the deformation of packaging materials.
- The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.
- The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.
- MSL=1

Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel
1206	3,000

Disclaimer

Specifications are subject to change without notice. AEM products are designed for specific applications and should not be used for any purpose (including, without limitation, automotive, aerospace, medical, life-saving applications, or any other application which requires especially high reliability for the prevention of such defect as may directly cause damage to the third party's life, body or property) not expressly set forth in applicable AEM product documentation. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Warranties granted by AEM shall be deemed void for products used for any purpose not expressly set forth in applicable AEM product documentation. AEM shall not be liable for any claims or damages arising out of products used in applications not expressly intended by AEM as set forth in applicable AEM product documentation. The sale and use of AEM products is subject to AEM terms and conditions of sale. Please refer to AEM's website for updated catalog and terms and conditions of sale.



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